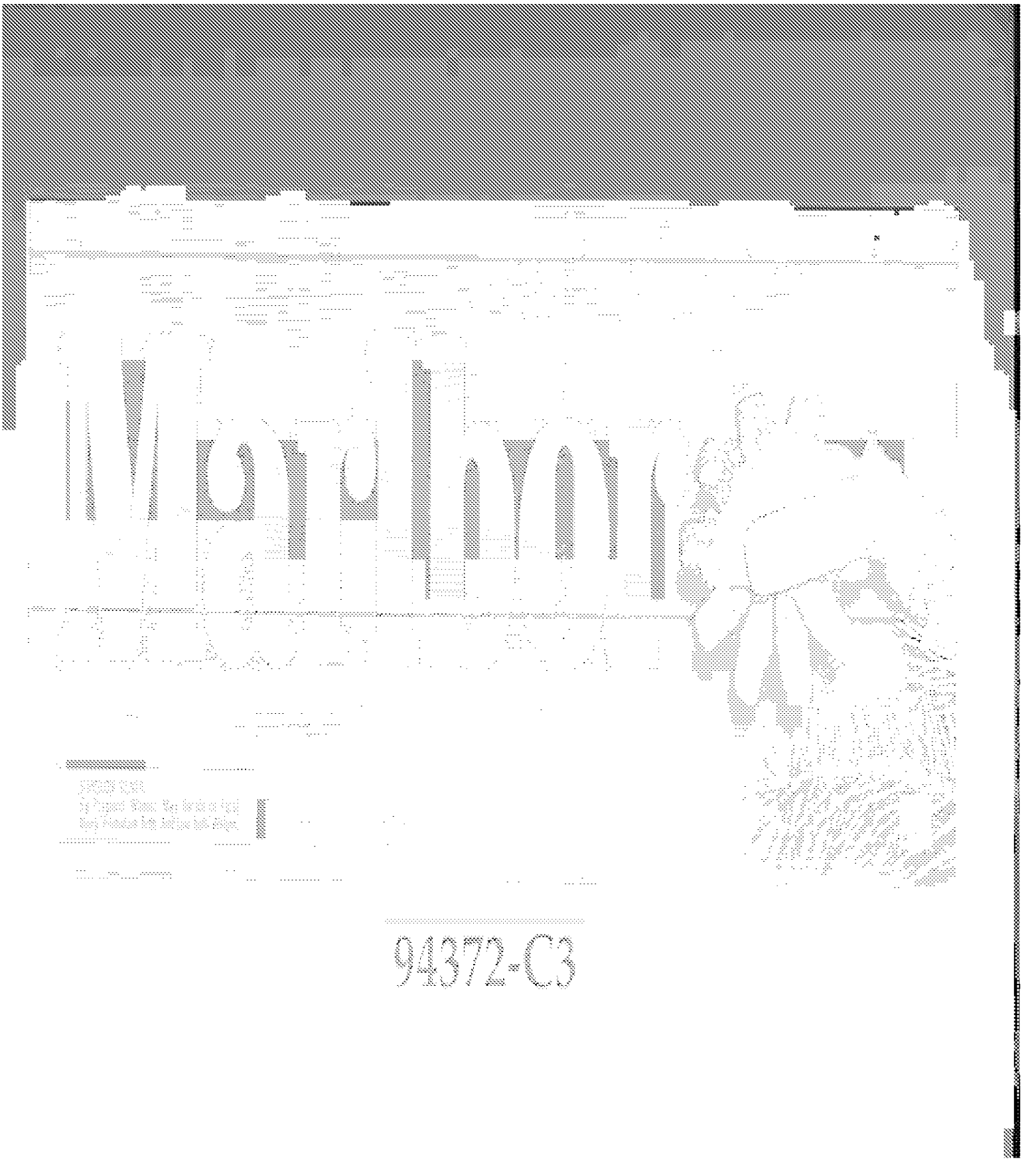
Source: https://www.industrydocuments.ucsf.edu/docs/xkly0003



94372-C3

2061169108